

01-06-1999

Docket No. 500.36608X00

FORM PTO 95
1-31-92

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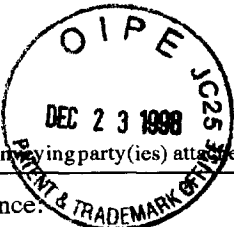
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To the Honorable Commissioner of Patents

Please return the attached original documents or copy thereof.

1. Name of conveying party(ies):
 Masanobu FUJII
 Haruaki SUE
 Shinya YAMADA

Additional name(s) of conveying party(ies) attached? Yes No



2. Name and address of receiving party(ies):
 Name: Hitachi Chemical Company, Ltd.
 Internal Address:
 Street Address: 1-1, 2-chome, Nishishinjuku, Shinjuku-ku
 City: Tokyo Country: Japan Zip:
 Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
 Execution Date: October 6, 1998 *MO 12-23-98*

4. Application number(s) or patent number(s):
 If this document is being filed together with a new application, the execution date of the application is:
 A. Patent Application No.(s)
 Serial No.: 09/166,128
 Filed: October 5, 1998
 B. Patent No.(s)
 Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
 Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP
 Internal Address:
 Street Address: 1300 North Seventeenth Street
 Suite 1800
 City: Arlington, State: VA Zip: 22209

6. Total number of applications and patents involved:
 7. Total fee (37 CFR 3.41)\$40.00
 Enclosed
 Any deficiencies may be charged to deposit account
 Authorized to be charged to deposit account
 8. Deposit account number: 01-2135
 (Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature. 40.00 OP
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William I. Solomon *William I. Solomon* December 23, 1998
 Name of Person Signing Signature Date
 Attorney Registration No. 28,565

Total number of pages including cover sheet, attachments, and document: 2

OMB No. 0651-0011 (exp. 4/94)

PATENT
REEL: 9673 FRAME: 0114

ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to Masanobu FUJII, Haruaki SUE, and Shinya YAMADA,

citizens of Japan by HITACHI CHEMICAL COMPANY, LTD., a corporation organized under the laws of Japan, located at 1-1, 2-chome, Nishishinjuku, Shinjuku-ku, Tokyo, Japan,

receipt of which is hereby acknowledged, we, the said Masanobu FUJII, Haruaki SUE, and Shinya YAMADA,

do hereby sell and assign to said HITACHI CHEMICAL COMPANY, LTD.,

~~their~~ its successors and assigns, all our right, title and interest, in and for the United States of America, in and to "EPOXY RESIN COMPOSITION AND SEMICONDUCTOR DEVICES USING IT AS ENCAPSULANT" invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extentions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI CHEMICAL COMPANY, LTD.,

~~their~~ its Successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extention, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI CHEMICAL COMPANY, LTD.

Signed on the dates indicated aside our signatures:

INVENTORS (発明者フルネームサイン)	Date Signed (署名日)	Witnesses (立会人サイン)
1) <u>Masanobu Fujii</u> (Masanobu FUJII)	6 Oct. 1998	<u>Tetsuo Saito</u>
2) <u>Haruaki Sue</u> (Haruaki SUE)	6 Oct., 1998	<u>Tetsuo Saito</u>
3) <u>Shinya Yamada</u> (Shinya YAMADA)	6 Oct. 1998	<u>Tetsuo Saito</u>
4) _____ ()	_____	_____
5) _____ ()	_____	_____
6) _____ ()	_____	_____
7) _____ ()	_____	_____
8) _____ ()	_____	_____

PATENT